



**GIG** VISION **GEN<i>i</i>CAM**



#### sensor information

sensor	ON Semiconductor PYTHON300
resolution	640 × 480 px
exposure time	0,02 ... 1000 ms
pixel size	4.8 × 4.8 μm
shutter type	Global shutter
sensor type	1/4" CMOS

#### acquisition formats

image formats, interface	Full Frame, 640 × 480 px, max. 403 fps
frame rate max.	Binning 2×2, 320 × 240 px, max. 595 fps Binning 2×1, 320 × 480 px, max. 595 fps Binning 1×2, 640 × 240 px, max. 595 fps
image formats, acquisition	Full Frame, 640 × 480 px, max. 595 fps
frame rate max. (Burst Mode)	
pixel formats	BayerRG8 BayerRG10 BayerRG12 BayerRG12 Packed Mono8 Mono10 Mono12 Mono12 Packed RGB8 BGR8

#### image preprocessing

analog controls	Gain (0 ... 12 dB) Offset (0 ... 63 LSB 10 Bit)
color models	Mono Raw Bayer RGB

#### interfaces and connectors

data interface	Gigabit Ethernet, Transfer rate 1000 Mb/s/sec, Fast Ethernet, Transfer Rate 100 Mb/s/sec, Connector: 8P8C Modular Jack (RJ45), screwable type
process interface	M8 / 8 pins (SACC-DSI-M8MS-8CON-M8-L180)
power supply	M8 / 8 pins or PoE

#### mechanical data

lens mount	C-mount
width	29 mm
height	29 mm
depth	49 mm
weight	≤ 120 g
material	zinc die casting, nickel-plated, IP 40

#### electrical data

voltage supply	12 ... 24 V DC (external power supply)
range +Vs	36 ... 57 V DC (Power over Ethernet)
power consumption	approx. 2,6 W @ 12 VDC and 403,0 fps approx. 3,2 W @ 48 VDC (PoE) and 403,0 fps

#### non-volatile memory

flash memory size	128 kB
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#### environmental conditions

operating temperature	+5 ... +65 °C @ T = measurement point
humidity	10 ... 90 % (non-condensing)
protection class	IP 40

#### digital I/Os

lines	1 input line 1 output line 2 general purpose lines
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#### conformity

conformity	CE RoHS KC (MISP-REI-BKR-VCXG-13M)
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**dimension drawing**

